

ISZ230N10NM6ATMA1-VB Datasheet

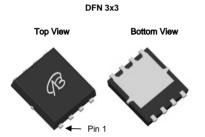
N-Channel 100V (D-S) MOSFET

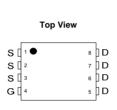
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a			
100	0.011 at V _{GS} = 10 V	50			
	0.014 at V _{GS} = 4.5 V	45			

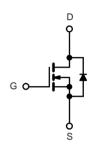
FEATURES

- 175 °C Junction Temperature
- SGT technology Power MOSFET
- Material categorization:









N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Gate-Source Voltage	V _{GS}	±20	V			
Continuous Drain Current (T _{.I} = 175 °C) ^b	T _C = 25 °C	I-	50			
Continuous Drain Current (1 _J = 175 °C) ³	T _C = 100 °C	l _D	30 ^a			
Pulsed Drain Current	I _{DM}	150	Α			
Continuous Source Current (Diode Conduction)	I _S	85 ^a	1			
Avalanche Current	I _{AS}	115				
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AS}	130	mJ		
Maximum Dowar Dissination	T _C = 25 °C	P _D	136	- W		
Maximum Power Dissipation	T _A = 25 °C] 'D	3 ^b , 8.3 ^{b, c}			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	- R _{thJA}	15	18	°C/W		
Waximum Junction-to-Ambient	Steady State		40	50			
Maximum Junction-to-Case		R _{thJC}	0.85	1.1			

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. $t \le 10$ s.

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Parameter	Symbol	ool Test Conditions Min.		Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ 100				V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	2	3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 100V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 100V, V _{GS} = 0 V, T _J = 175 °C			250	1	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	60			Α	
		V _{GS} = 10 V, I _D = 20 A	0.011				
D : 0	D	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.016		0	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.022		Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{A}$		0.014			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic	•			•	1		
Input Capacitance	C _{iss}			5000			
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		470		pF	
Reverse Transfer Capacitance	C _{rss}			225			
Total Gate Charge ^c	Q_g			70	70		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		11		nC	
Gate-Drain Charge ^c	Q_{gd}			13			
Turn-On Delay Time ^c	t _{d(on)}			19	25		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		16	23	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong 50$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		36	56		
Fall Time ^c	t _f			25	35		
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)					
Pulsed Current	I _{SM}				150	Α	
Diode Forward Voltage	V_{SD}	$I_F = 20 \text{ A}, V_{GS} = 0 \text{ V}$		1	1.5	V	
Reverse Recovery Time	t _{rr}	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		4	135	ns	

Notes:

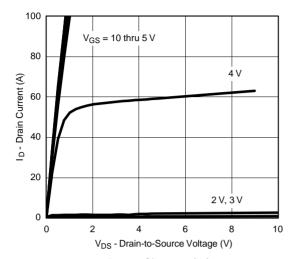
- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

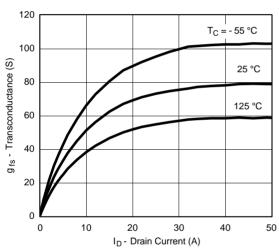
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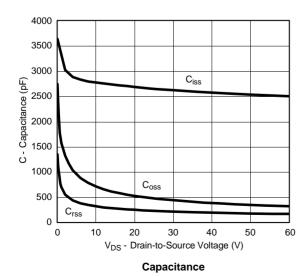
TYPICAL CHARACTERISTICS (25 °C unless noted)



Output Characteristics

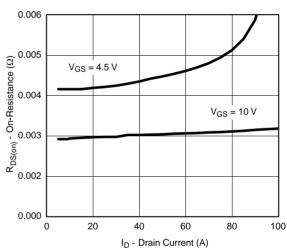


Transconductance

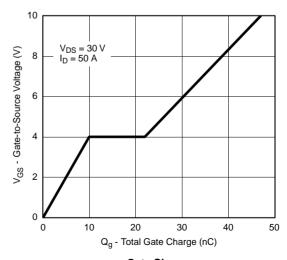


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Transfer Characteristics



On-Resistance vs. Drain Current

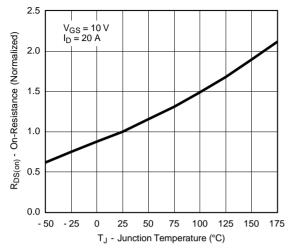


Gate Charge

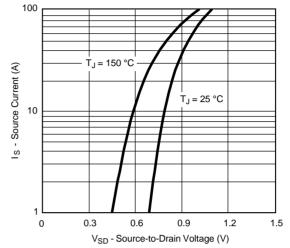
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TYPICAL CHARACTERISTICS (25 °C unless noted)



On-Resistance vs. Junction Temperature

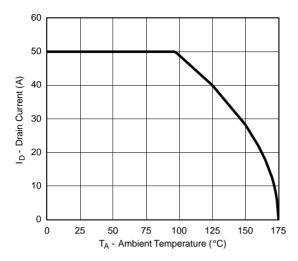


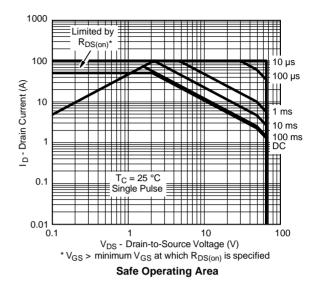
Source-Drain Diode Forward Voltage

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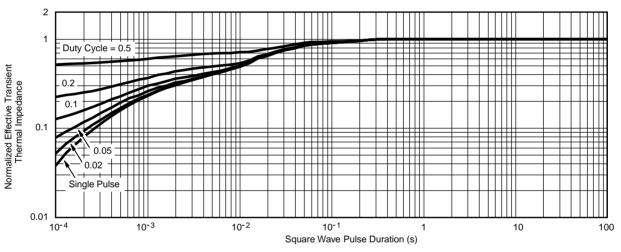


THERMAL RATINGS





Maximum Drain Current vs. Ambient Temperature



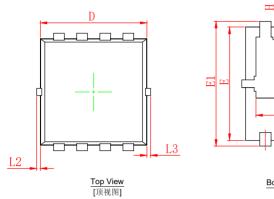
Normalized Thermal Transient Impedance, Junction-to-Case

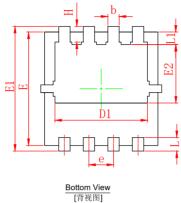
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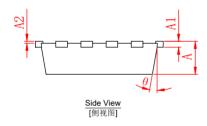
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PDFNWB3×3-8L Package Outline Dimensions

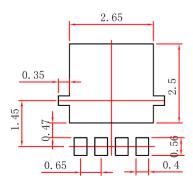






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.650	0.850	0.026	0.033	
A1	0.203RE	ΞF.	0.008REF.		
A2	0~0.0	5	0~0	0~0.002	
D	2.900	3.100	0.114	0.122	
D1	2.050	2.550	0.081	0.100	
E	2.900	3.100	0.114	0.122	
E1	3.150	3.450	0.124	0.136	
E2	1.450	1.650	0.057	0.065	
b	0.200	0.400	0.008	0.016	
е	0.550	0.750	0.022	0.030	
L	0.300	0.500	0.012	0.020	
L1	0.180	0.480	0.007	0.019	
L2	0~0.100		0~0.004		
L3	0~0.100		0~0.004		
Н	0.315	0.515	0.012	0.020	
Φ	9°	13°	9°	13°	

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
- 3. The pad layout is for reference purposes only.

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